

80V N-Channel Trench MOSFET

Features		Product Summary		
 Trench Power Technology Low R_{DS(ON)} 		Vds	80V	
 Low Gate Charge 		$R_{DS(ON)}$ (at V _{GS} =10V) < 7.5m2		
Optimized for Fast-switching Applica	tions	I _D (at V _{GS} =10V) 115A		
Applications				
• Synchronous Rectification in DC/DC	and AC/DC Converters	100% UIS Tested		
Isolated DC/DC Converters in Teleco	om and Industrial		RoHS	シ
G D S	GDS		Gate Source	
Device	Pack	age	Marking	
TTB115N08A	TO-2	263	115N08A	
TTP115N08A	TO-2	220	115N08A	
Absolute Maximum Ratings	T _C = 25°C, unless	otherwise noted		
Parameter		Symbol	Value	Unit
Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	80	V
	$T_{c} = 25^{\circ}C$		115	

Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	80	V
	$T_{\rm C} = 25^{\circ}{\rm C}$		115	
Continuous Drain Current	T _C = 100°C	Ι _D	80	A
Pulsed Drain Current	1) I _{DM}	460	А	
Gate-Source Voltage		V _{GSS}	±20	V
Single Pulse Avalanche Energy (not		2) E _{AS}	390	mJ
Avalanche Current	I _{As}	51	А	
Power Dissipation (note?)	$T_{\rm C} = 25^{\circ}{\rm C}$		200	W
Power Dissipation (note3	T _C = 100°C	– P _D	100	W
Operating Junction and Storage Tempera	T _J , T _{stg}	-55~+175	°C	

Thermal Resistance				
Parameter	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	0.75	°C/W	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	°C/W	

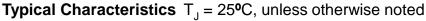


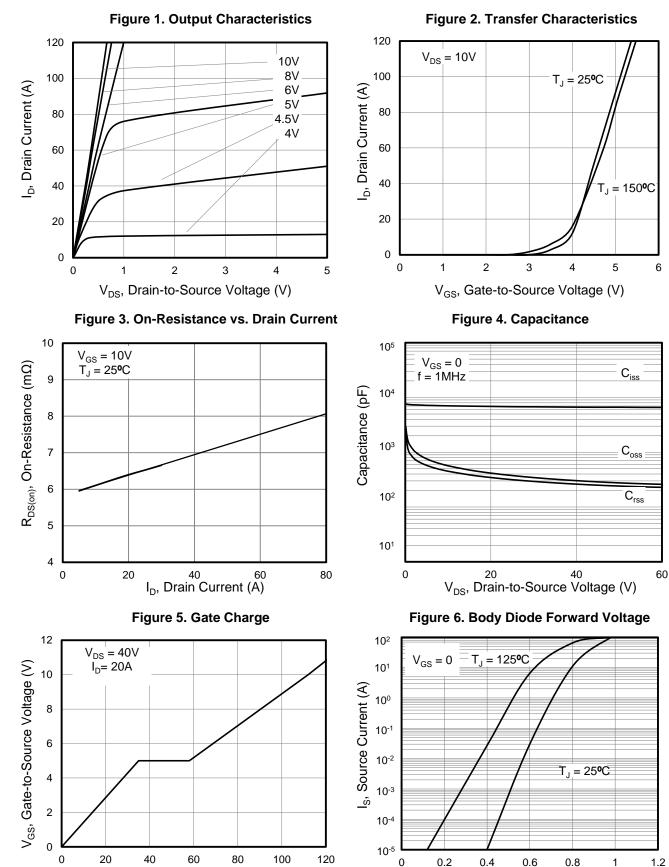
Specifications $T_J = 25^{\circ}C$, u	unless othe	rwise noted				
Devementer			Value			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			•	•		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	82			V
		$V_{DS} = 82V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 82V, V_{GS} = 0V, T_{J} = 100^{\circ}C$			25	μA
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	3	4	V
Drain-Source On-Resistance	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 20A$		6.4	7.5	mΩ
Forward Transconductance	9 _{fs}	$V_{DS} = 5V, I_{D} = 20A$	80			S
Dynamic	-					
Input Capacitance	C _{iss}	V _{GS} = 0V,		6650		pF
Output Capacitance	C _{oss}	$V_{DS} = 40V$,		302		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		261		
Total Gate Charge	Qg			112		
Gate-Source Charge	Q _{gs}	$V_{DD} = 40V, I_{D} = 20A, V_{GS} = 10V$		35		nC
Gate-Drain Charge	Q _{gd}			23		
Turn-on Delay Time	t _{d(on)}			24		
Turn-on Rise Time	t _r	V _{DD} = 40V, I _D = 20A,		19		
Turn-off Delay Time	t _{d(off)}	$R_{G} = 2.5\Omega$		70		ns
Turn-off Fall Time	t _f			30		
Drain-Source Body Diode Characte	ristics			-		
Continuous Body Diode Current	۱ _s	T 2500			115	^
Pulsed Diode Forward Current	I _{SM}	$T_{\rm C} = 25^{\rm o}{\rm C}$			460	A
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 20A, V _{GS} = 0V			1.2	V
Reverse Recovery Time	t _{rr}	I _F = 20A,		37		ns
Reverse Recovery Charge	Q _{rr}	di _F /dt = 100Å/µs		58		nC

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 51A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. The power dissipation PD is based on TJ(MAX)=175° C, using junction-to-case thermal resistance.



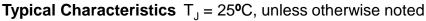


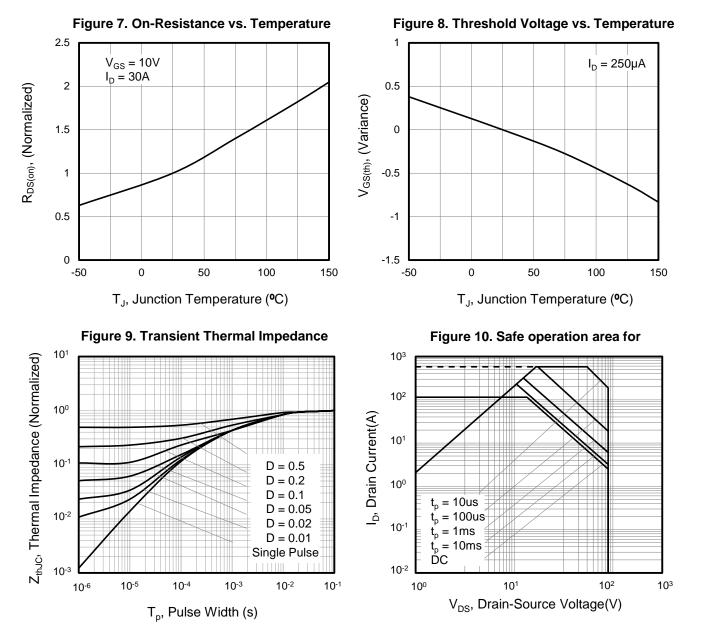


V_{SD}, Source-to-Drain Voltage (V)

Q_q, Total Gate Charge (nC)









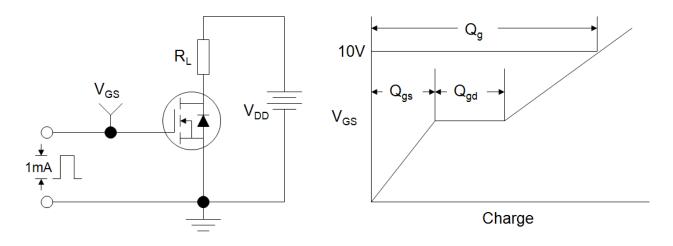


Figure B: Resistive Switching Test Circuit and Waveform

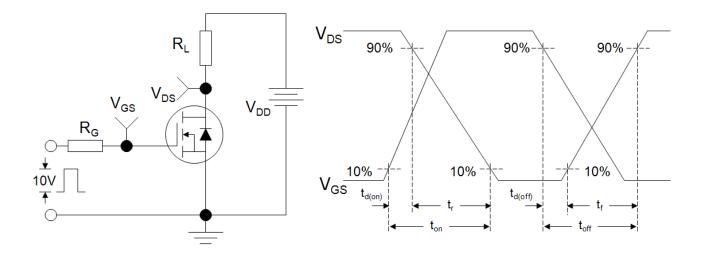
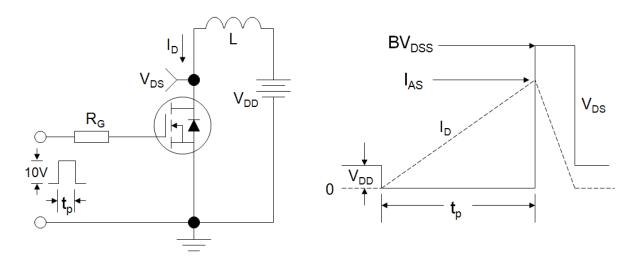
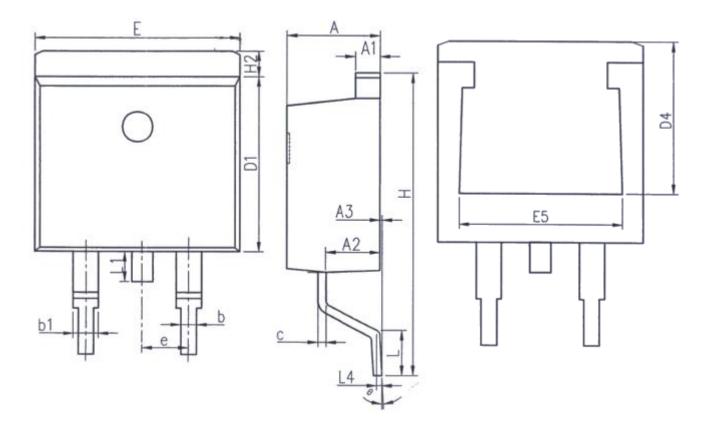


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





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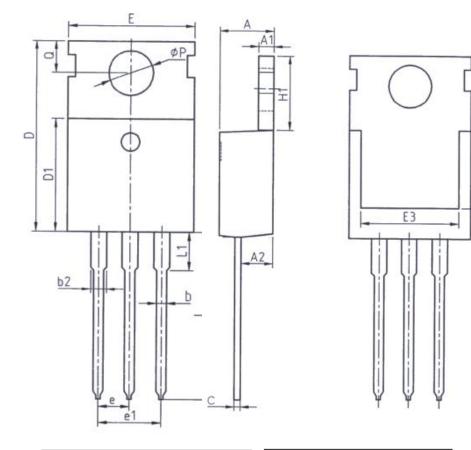
	Unit: mm		l	Unit: mm	n
Symbol	Min.	Max.	Symbol	Min.	Max.
Α	4. 37	4. 77	E	9.86	10.36
A1	1.22	1.42	E 5	7.06	-
A2	2.49	2.89	e	2. 54BSC	
A3	0.00	0. 25	Н	14. 70	15.50
b	0.70	0.96	H2	1.07	1.47
b1	1.17	1.47	L	2.00	2.60
с	0.30	0.53	L1	1.40	1.70
D1	8.50	8.90	L4	0. 25BSC	
D4	6. 60	-	θ	0°	9 °

02

E

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TO-220



Unit: mm			
Symbol	Max.		
Α	4. 37	4.77	
A1	1.25	1.45	
A2	2.20	2.60	
b	0.70	0.95	
b2	1.17	1.47	
C	0.40	0.65	
D	15.10	16. 10	
D1	8.80	9.40	
D2	5.50	-	

Unit: mm				
Symbol	Min. Max.			
E	9.70	10. 30		
E3	7.00	-		
e	2. 54BSC			
e1	5. 08BSC			
H1	6. 25	6.85		
L	12.75 13.80			
L1	- 3.40			
Ρ	3.40 3.80			
Q	2.60	3.00		



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